



B1100LB

1.0A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER

Features

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 50A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- High Temperature Soldering: 260°C/10 Second at Terminal
- Lead Free Finish, RoHS Compliant (Note 1)
- **Green Molding Compound (No Halogen and Antimony)** (Note 2)

Mechanical Data

- Case: SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 @3:
- Polarity: Cathode Band or Cathode Notch
- Weight: 0.093 grams (approximate)





Ordering Information (Note 3)

Part Number	Case	Packaging
B1100LB-13-F	SMB	3000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes. 2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



B1100LB = Product type marking code ⊃!!= Manufacturers' code marking YWW = Date code marking Y = Last digit of year (ex: 02 for 2002) WW = Week code (01 to 53)

Note: Device has a cathode band and may also have a cathode notch.

1 of 4 B1100LB September 2010 Document number: DS30077 Rev. 10 - 2 © Diodes Incorporated



Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	@ I _R = 0.5mA	V _{RRM} V _{RWM} V _R	100	V
RMS Reverse Voltage		V _{R(RMS)}	70	V
Average Rectified Output Current	@ T _T = 120°C @ T _T = 100°C	Io	1.0 2.0	А
Non-Repetitive Peak Forward Surge Curre 8.3ms Single half sine-wave Superimposed	I _{FSM}	50	А	

Thermal Characteristics

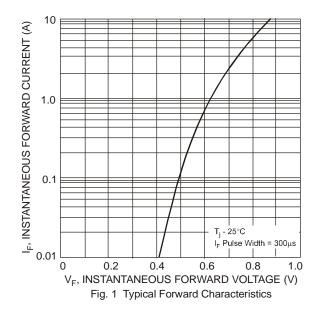
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Terminal (Note 4)	$R_{ heta JT}$	22	°C/W
Operating and Storage Temperature Range (Note 5)	T _{J.} T _{STG}	-65 to +175	°C

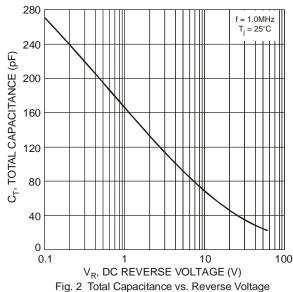
Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	VF	•	-	0.75	V	I _F = 1.0A, T _A = 25°C
Leakage Current (Note 6)	I _R		-	0.5 5.0	l ma	$V_R = 100V, T_A = 25^{\circ}C$ $V_R = 100V, T_A = 100^{\circ}C$
Total Capacitance	C _T	-	-	100	pF	$V_R = 4V, f = 1MHz$

Notes:

- 4. Valid provided that terminals are kept at ambient temperature. 5. The heat generated must be less than the thermal conductivity from Junction-to-Ambient: $dP_D/dT_J < 1/R_{BJA}$.
- 6. Short duration pulse test used to minimize self-heating effect.

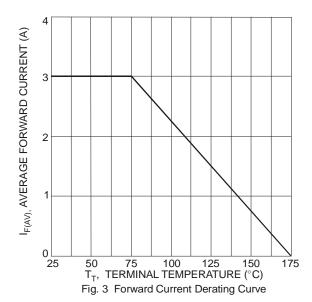


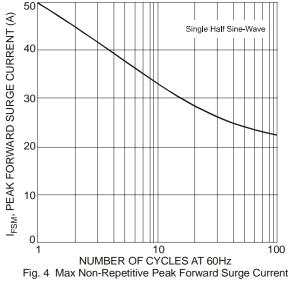


B1100LB Document number: DS30077 Rev. 10 - 2 2 of 4

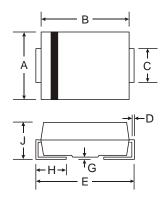
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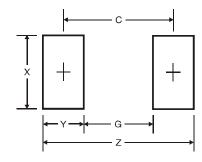


Package Outline Dimensions



SMB				
Dim	Min	Max		
Α	3.30	3.94		
В	4.06	4.57		
С	1.96	2.21		
D	0.15	0.31		
Е	5.00	5.59		
G 0.05 0.20				
H 0.76 1.52				
J	2.00	2.50		
All Dimensions in mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Z	6.8
G	1.8
Х	2.3
Υ	2.5
С	4.3



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4 of 4 B1100LB September 2010 Document number: DS30077 Rev. 10 - 2 © Diodes Incorporated

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